

Image

SP01-302

1731

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: COOK, et al

Serial No: 10/035659

Filed: 10/26/2001

For: DIRECT BONDING OF GLASS
ARTICLES FOR DRAWING

Examiner: To Be Assigned

Group Art Unit: 1731

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98

Commissioner of Patents
Alexandria, VA 22313-1450

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference(s) is enclosed.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

The undersigned attorney is granted limited recognition by the Office of Discipline and Enrollment of the USPTO to practice before the USPTO in capacity as an employee of Corning Incorporated. A copy of the document granting such limited recognition either has been previously submitted or is submitted herewith for the record.

Please direct any questions or comments to the undersigned at (607) 248-1253.

Respectfully submitted,

Siwen Chen
Corning Incorporated
SP-TI-03-1
Corning, NY 14831
607-248-1253

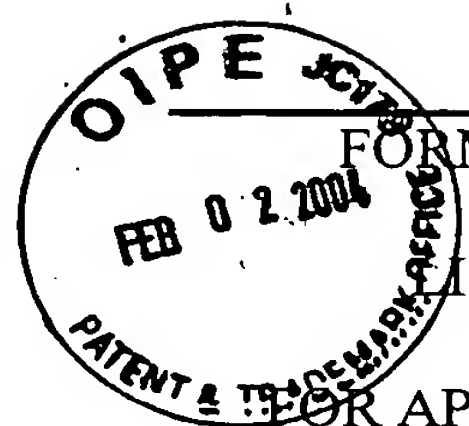
Date: January 28, 2004

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner of Patents, Alexandria, VA 22313-1450 on

1-29-04

Date of Deposit

Signature: Colleen E. Doherty



FORM PTO-1449 (MODIFIED)

LIST OF PATENTS AND
PUBLICATIONS

FOR APPLICANTS INFORMATION
DISCLOSURE STATEMENT

ATTORNEY DOCKET NO.

SP01-302

SERIAL NO.

10/035659

APPLICANT: COOK, et al.

FILING DATE 10/26/2001

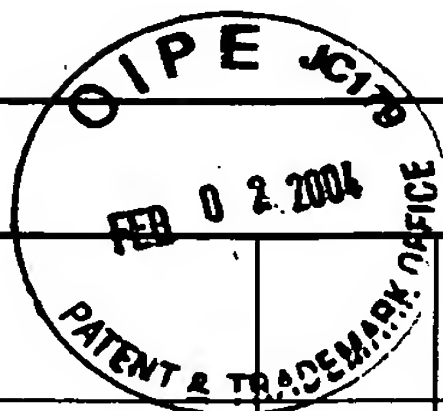
GROUP: 1731

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date if Approp.
	AA	4,186,999	2/5/80	Harwood et al	350	96.21	
	AB	4,530,452	7/23/85	Balyasny et al	225	96	
	AC	4,626,068	12/2/86	Caldwell	350	96.34	
	AD	5,183,710	2/2/93	Gerbino	428	405	
	AE	5,346,583	9/13/94	Basavanhally	156	629	
	AF	5,451,547	9/19/95	Himi et al	437	225	
	AG	5,452,122	9/19/95	Tsuneda et al	359	281	
	AH	5,579,421	11/26/96	Duvall et al	385	14	
	AI	5,631,986	5/20/97	Frey et al	385	78	
	AJ	5,846,638	12/8/98	Meissner	428	220	
	AK	5,852,622	12/22/98	Meissner et al	372	39	
	AL	5,989,372	11/23/99	Momoda et al	156	89.11	
	AM	6,030,883	2/29/00	Nishimoto et al	438	455	
	AN	6,048,103	4/11/00	Furukata et al	385	73	
	AO	6,249,619	6/19/01	Bergmann et al	385	11	
	AP	6,275,336	8/14/01	Yoshikawa et al	359	484	
	AQ	6,359,733	3/19/02	Iwatsuka et al	359	500	
	AR	6,583,029	6/24/03	Abe et al	438	455	
	AS	2002/0108556	8/15/02	Ebbers	117	2	
	AT	2003/0079503	5/1/03	Cook et al	65	407	
	AU	2003/0079823	5/1/03	Sabia	156	99	
	AV	2003/0081906	5/1/03	Filhaber et al	385	60	
	AW	2003/0206345	11/6/03	Sabia et al	359	484	
	AX	2003/0206347	11/6/03	Sabia et al	359	484	
	AY	2003/0081930	5/1/03	Filhaber et al	385	147	
	AZ	4,960,331	10/2/90	Goldman et al	356	350	
	A1	5,319,483	6/7/94	Krasinski et al	359	113	
	A2	5,441,803	8/15/95	Meissner	428	220	
	A3	5,689,519	11/18/97	Fermann et al	372	18	
	A4	6,120,917	9/19/00	Eda	428	692	
	A5	6,548,176	4/15/03	Gwo	428	420	
	A6	6,621,630	9/16/03	Iwatsuka	359	484	

FORM PTO-1449 (MODIFIED) LIST OF PATENTS AND PUBLICATIONS FOR APPLICANTS INFORMATION DISCLOSURE STATEMENT	ATTORNEY DOCKET NO.	SERIAL NO.
	SP01-302	10/035659
	APPLICANT: COOK, et al.	
	FILING DATE 10/26/2001	GROUP: 1731



FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	Sub-Class	Translation Yes No	
AA	WO01/98225	12/27/01	PCT	C03C	27/06		
AB	WO00/17698	3/30/00	PCT	G02F	1/09		
AC	DE19731075	1/21/99	Germany	C03C	29/00		
AD	DE2130905	1/11/73	Germany	H01j	19/56		
AE	08-146351	6/7/96	Japan (English Abstract)	G02B	27/28		
AF	2002321947	4/25/01	Japan (English Abstract)	C03C	27/00		
AH	03-115178	5/16/91	Japan (English Abstract)	C04B	37/00		

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

AI	ONISHI et al., "A novel temperature compensation method for SAW devices using direct bonding Techniques," <i>Ultrasonics Symp</i> , 1997, IEEE Proceedings, 5-8 Oct, 1997 Pages 227-230.
AK	Arthur Landrock; "Surface Preparation of Adherends"; Adhesives Technology Handbook; 1985; page 117-118

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.